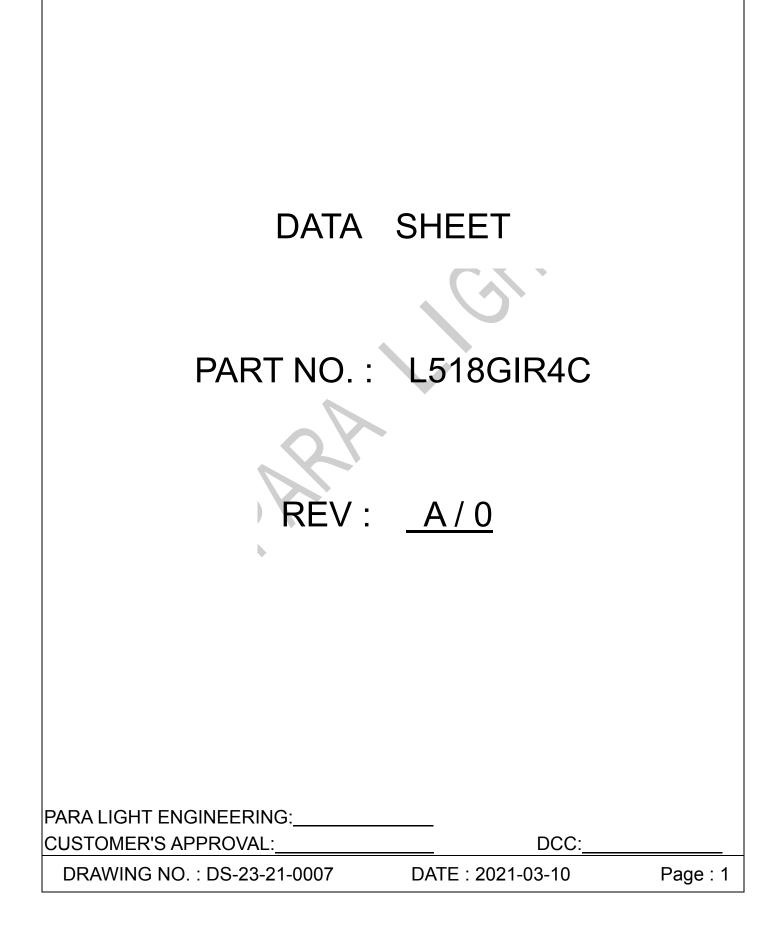


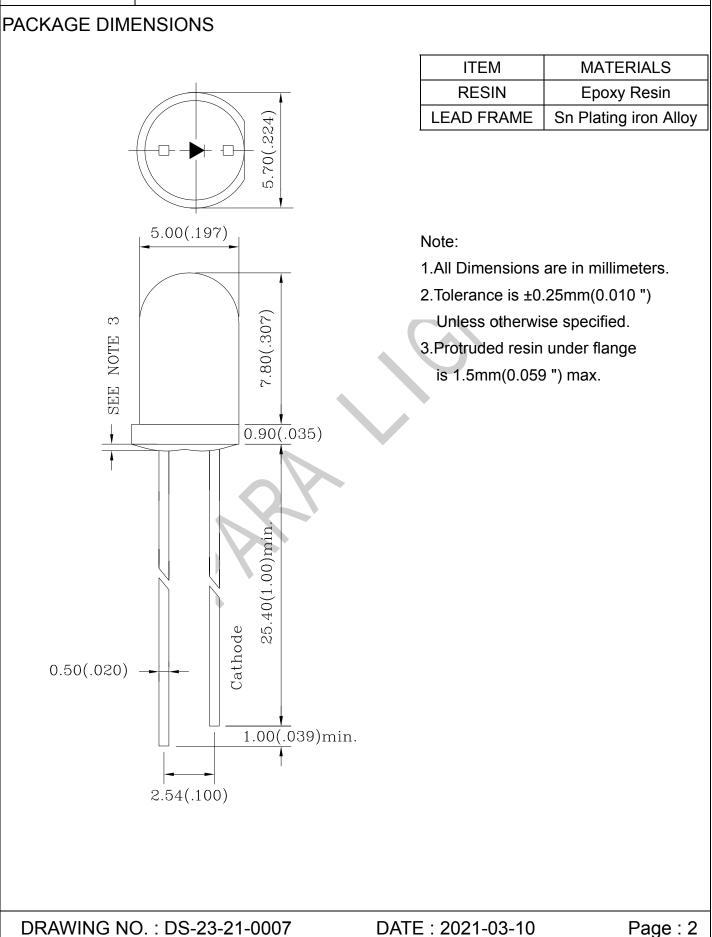
PARA LIGHT ELECTRONICS CO., LTD. 11F., No. 8, Jiankang Rd., Zhonghe Dist., New Taipei City 235, Taiwan, Tel: 886-2-2225-3733 Fax: 886-2-2225-4800 E-mail: para@para.com.tw www.paralighttaiwan.com





#### L518GIR4C

REV:A/0



# PARA ight

#### L518GIR4C

REV:A/0

#### FEATURES

- \* High-brightness
- \* High reliability
- \* Low-voltage characteristics
- \* Narrow view angle
- \* Pb FREE Products
- \* RoHS Compliant

#### CHIP MATERIALS

- \* Dice Material : GaAlAs/GaAs
- \* Lens Color : WATER CLEAR

#### ABSOLUTE MAXIMUM RATING : ( Ta = 25°C )

SYMBOL	PARAMETER	MAX	UNIT
PD	Power Dissipation Per Chip	200	mW
Vr	Reverse Voltage Per Chip	5	V
lf	Forward Current Per Chip	100	mA
IFP	Peak forward current (F=1KHZ,duty=0.1)	400	mA
Topr	Operating Temperature Range	-25°C to 85°C	
Tstg	Storage Temperature Range	-25°C to 85°C	

IFP Condition : Pulse Width≤10msec, 10% duty cycle

ELECTRO-OPTICAL CHARACTERISTICS : ( Ta = 25°C )

SYMBOL	PARAMETER	TEST	MINI	TYP.		
		CONDITION	MIN.	ITP.	MAX.	UNIT
VF	Forward Voltage	IF = 70mA		1.4	1.8	V
		IF = 100mA		1.5	1.8	V
IR	Reverse Current	VR = 5V			10	μA
λр	Peak Emission Wavelength	IF = 70mA		850		nm
201/2	Half Intensity Angle	IF = 70mA		40		deg
le	Radiant Intensity	IF = 70mA		60		mw/sr
		IF=100mA		85		

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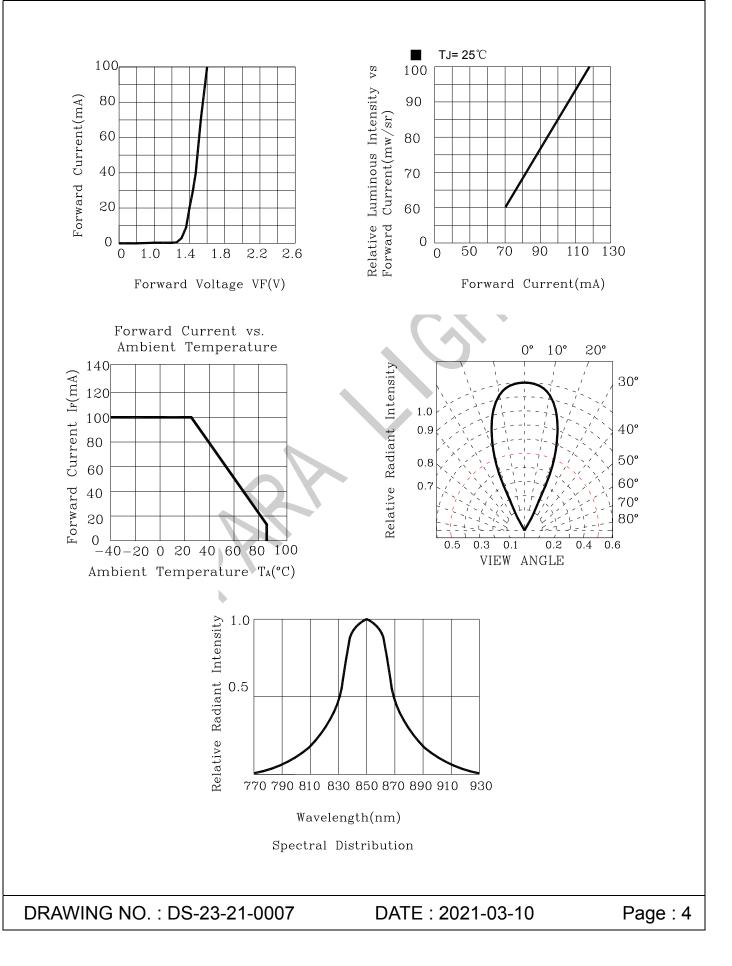
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### L518GIR4C

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#### Label Explanation

PARA LIGHT ELECTRONICS CO.,LTD.					
PART NO : L518GIR4C-HB					
LOT NO :	INSPECTED				
BIN :					
Q'TY:PCS					
N.W : g					

PART NO. : L518GIR4C

Refer to page 12

#### LOT NO.: E L L 4 7 0009

B C D E

F

A---E: For series number

А

- B---L: Local F: Foreign
- C---L: LAMP
- D---Year
- E---Month
- F--- Serial number

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DATE : 2021-03-10

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### L518GIR4C

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•SOLDERING

•SULDERING				
METHOD	SOLDERING CONDITIONS	REMARK		
DIP SOLDERING	Bath temperature: 260℃ Immersion time: within 3 sec, 1 time	<ul> <li>Solder no closer than 3mm from the base of the package</li> <li>Using soldering flux," RESIN FLUX" is recommended.</li> </ul>		
SOLDERING IRON	Soldering iron: 30W or smaller Temperature at tip of iron: 300℃ or lowe Soldering time: within 3 sec.	<ul> <li>During soldering, take care not to press the tip of iron against the lead.</li> <li>(To prevent heat from being transferred directly to the lead, hold the lead with a pair of tweezers while soldering)</li> </ul>		
1) When solderi	ng the lead of LED in a condition that the	package is fixed with a panel (See Fig.1),		
be careful not	t to stress the leads with iron tip.			
	Panel (Fig. 1)	l wries		
2) When solderi	ng wire to the lead, work with a Fig (See	Fig.2) to avoid stressing the package.		
Leave a cle	slight arance	(Fig. 2)		
Regarding tinning the leads, compound made of tin ,copper and sliver is proposed with the temperature of 260 $^{\circ}$ C. The proportion of the alloyed solution is 95.5% tin, 3.5% copper, 0.5% silver. The time of tinning is 3 seconds.				

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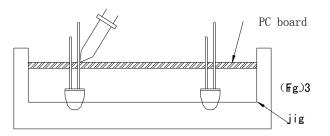


### 5.0 mm INFRARED EMITTING DIODE

#### L518GIR4C

#### REV:A/0

3) Similarly, when a jig is used to solder the LED to PC board, take care as much as possible to avoid stressing the leads (See Fig.3).



- 4) Repositioning after soldering should be avoided as much as possible. If inevitable: select a best-suited method that assures the least stress to the LED.
- Lead cutting after soldering should be performed only after the LED temperature has returned to normal temperature.

#### • STORAGE

- The LEDs should be stored at 30°C or less and 70% RH or less after being shipped from PARA and the storage life limit is 1 year.
- 2) PARA LED lead frames are comprised of a tin plated iron alloy. The surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LEDs to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- 3) Please avoid rapid changes in ambient temperature, especially, in high humidity environments where condensation can occur.



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#### • STATIC ELECTRICITY

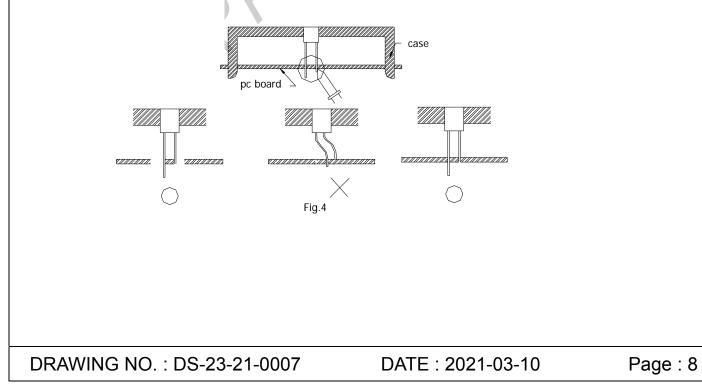
Static electricity or surge voltage damages the LEDs.
 It is recommended that a wrist band and an anti-electrostatic glove be used when handling the LEDs.

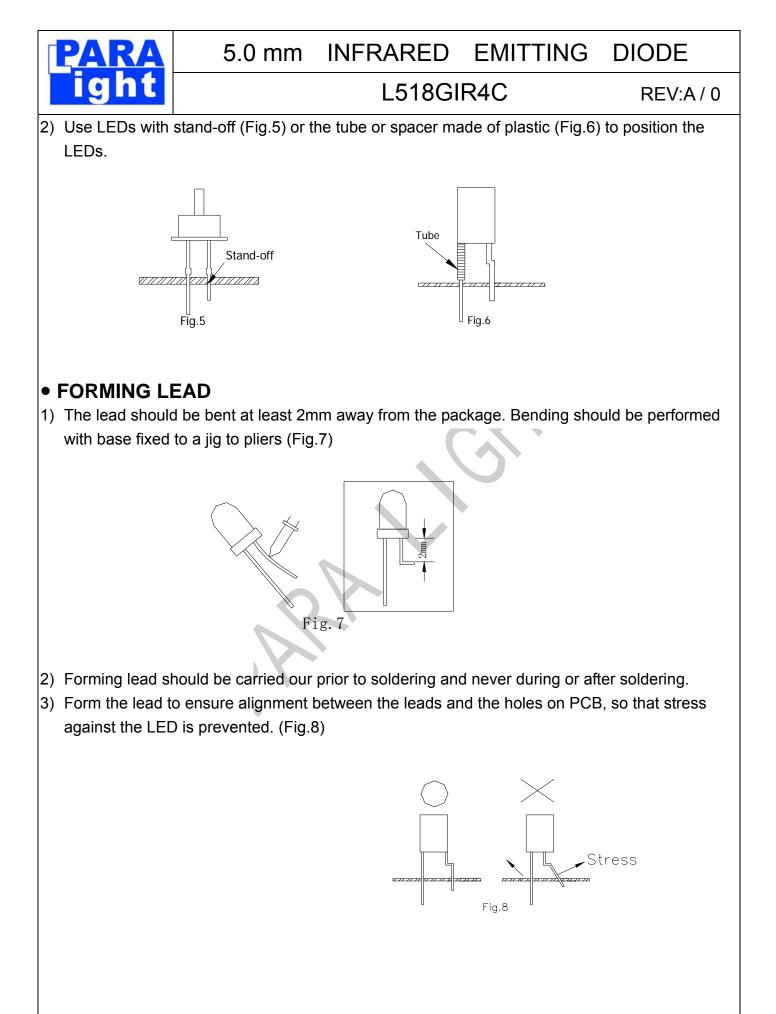
- 2) All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the LED mounting equipment.
- 3) When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity. To find static-damaged LEDs, perform a light-on test or a VF test at a lower current (below 1mA is recommended).
- 4) Damaged LEDs will show some unusual characteristics such as the leakage current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.

Criteria : ( VF>2.0V at IF=0.5mA )

#### • LED MOUNTING METHOD

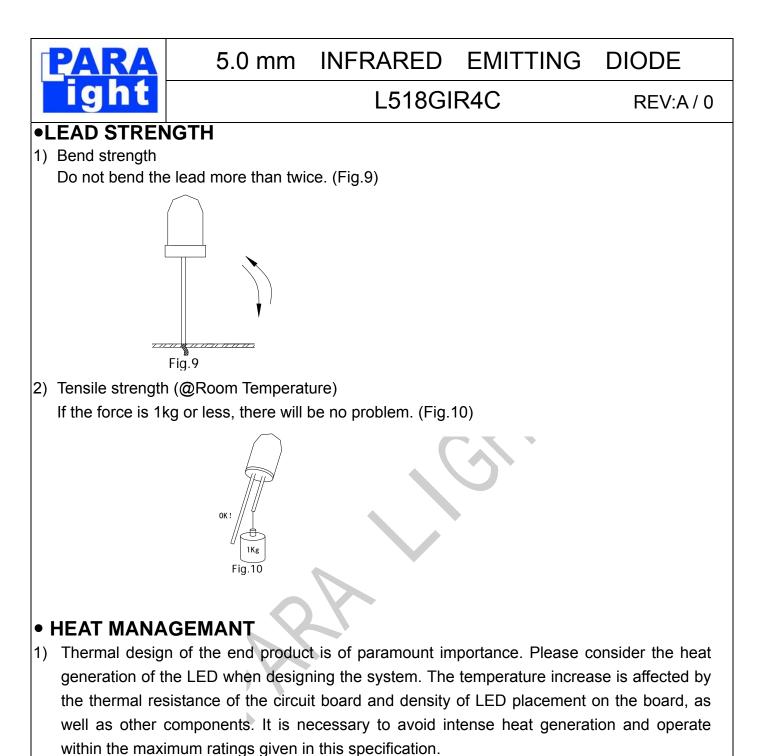
1) When mounting the LED to a housing, as shown on Fig.4, ensure that the mounting holes on the PC board match the pitch of the leads correctly. Tolerance of dimensions of the respective components including the LEDs should be taken into account especially when designing the housing, PC board, etc. to prevent pitch misalignment between the leads and holes on PCB, the diameter of the holes should be slightly larger than the size of the lead. Alternatively, the shape of the holes could be made oval. (See Fig.4)





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The operating current (IF) should be decided after considering the ambient maximum temperature of LEDs.

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#### •CHEMICAL RESISTANCE

- 1) Avoid exposure to chemicals as it may attack the LED surface and cause discoloration.
- 2) When washing is required, refer to the following table for the proper chemical to be used. (Immersion time: within 3 minutes at room temperature.)

SOLVENT	ADAPTABILITY
Freon TE	$\odot$
Chlorothene	$\times$
Isopropyl Alcohol	$\odot$
Thinner	$\times$
Acetone	$\times$
Trichloroethylene	X
$\sim \sim $	

 $\odot$ --Usable  $\times$ --Do not use.

#### NOTE: Influences of ultrasonic cleaning of the LED resin body differ depending on factors such as the oscillator output, size of the PC board and the way in which the LED is mounted. Therefore, ultrasonic cleaning should only be performed by confirming an ultrasonic cleaning trial run.

#### •OTHER CONSIDERTIONS

- 1) Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- 2) The LEDs described in this data sheet are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult PARA's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, spacecraft, automobiles, traffic control equipment etc).
- 3) The formal specifications must be exchanged and signed by both parties before large volume purchase begins.



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